### SN74LVCZ16240A 16-BIT BUFFER/DRIVER WITH 3-STATE OUTPUTS

SCES276B - JUNE 1999 - REVISED MARCH 2000

<ul> <li>Member of the Texas Instruments Widebus™ Family</li> </ul>	DGG OR DL PACKAGE (TOP VIEW)		
<ul> <li>EPIC™ (Enhanced-Performance Implanted CMOS) Submicron Process</li> </ul>	1 <del>0E</del> [ 1 1Y1 [ 2	48 2 <del>0E</del> 47 1A1	
<ul> <li>Typical V<sub>OLP</sub> (Output Ground Bounce)</li> <li>&lt;0.8 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C</li> </ul>	1Y2 3 GND 4	46 1A2 45 GND	
<ul> <li>Typical V<sub>OHV</sub> (Output V<sub>OH</sub> Undershoot)</li> <li>&gt;2 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C</li> </ul>	1Y3 [ 5 1Y4 [ 6	44 🛭 1A3	
<ul> <li>I<sub>off</sub> and Power-Up 3-State Support Hot Insertion</li> </ul>	V <sub>CC</sub> [ 7 2Y1 [ 8		
<ul> <li>Supports Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V V<sub>CC</sub>)</li> </ul>	2Y2	40 2A2 39 GND 38 2A3	
Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II	2Y4 [ 12 3Y1 [ 13	37   2A4 36   3A1	
<ul> <li>ESD Protection Exceeds JESD 22</li> <li>2000-V Human-Body Model (A114-A)</li> <li>200-V Machine Model (A115-A)</li> </ul>	3Y2 [ 14 GND [ 15 3Y3 [ 16		
<ul> <li>1000-V Charged-Device Model (C101)</li> <li>Package Options Include Plastic Shrink</li> </ul>	3Y4 17 V <sub>CC</sub> 18	32 3A4 31 V <sub>CC</sub>	
Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages	4Y1 [] 19 4Y2 [] 20 GND [] 21	30 4A1 29 4A2 28 GND	
description	4Y3 22 4Y4 23	27 4A3 26 4A4	
This 16-bit buffer/driver is designed for 3-V to	4 <del>0E</del> [ 24	25 3 <del>0E</del>	

The SN74LVCZ16240A is designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters.

The device can be used as four 4-bit buffers, two 8-bit buffers, or one 16-bit buffer. This device provides inverting outputs and symmetrical active-low output-enable  $(\overline{OE})$  inputs.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of these devices as translators in a mixed 3.3-V/5-V system environment.

When  $V_{CC}$  is between 0 and 1.5 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 1.5 V,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

This device is fully specified for hot-insertion applications using I<sub>off</sub> and power-up 3-state. The I<sub>off</sub> circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down. The power-up 3-state circuitry places the outputs in the high-impedance state during power up and power down, which prevents driver conflict.

The SN74LVCZ16240A is characterized for operation from –40°C to 85°C.



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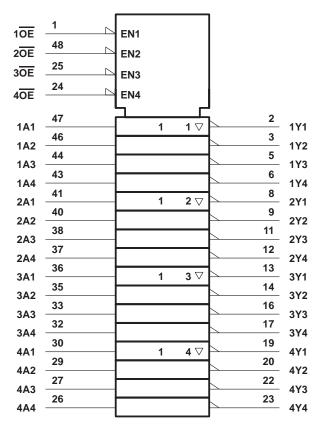


3.6-V V<sub>CC</sub> operation.

# FUNCTION TABLE (each 4-bit buffer)

INP	JTS	OUTPUT
OE	Α	Υ
L	Н	L
L	L	Н
Н	Χ	Z

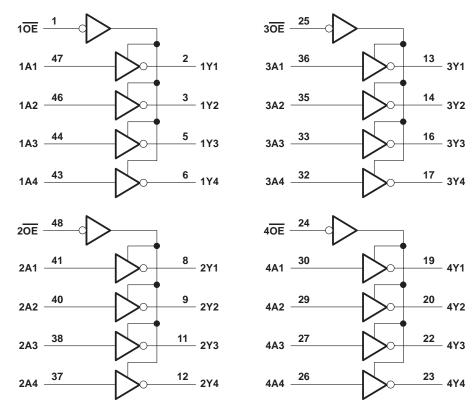
## logic symbol†



<sup>&</sup>lt;sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



## logic diagram (positive logic)



### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>	–0.5 V to 6.5 V
Input voltage range, V <sub>I</sub> (see Note 1)	0.5 V to 6.5 V
Voltage range applied to any output in the high-impedance or power-off state, Vo	
(see Note 1)	0.5 V to 6.5 V
Voltage range applied to any output in the high or low state, VO	
(see Notes 1 and 2)	. $-0.5$ V to V <sub>CC</sub> + $0.5$ V
Input clamp current, $I_{IK}$ ( $V_I < 0$ )	
Output clamp current, $I_{OK}$ ( $V_O < 0$ )	–50 mA
Continuous output current, I <sub>O</sub>	±50 mA
Continuous current through each V <sub>CC</sub> or GND	±100 mA
Package thermal impedance, θ <sub>JA</sub> (see Note 3): DGG package	
DL package	63°C/W
Storage temperature range, T <sub>Stq</sub>	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

- 2. The value of V<sub>CC</sub> is provided in the recommended operating conditions table.
- 3. The package thermal impedance is calculated in accordance with JESD 51.



## SN74LVCZ16240A 16-BIT BUFFER/DRIVER WITH 3-STATE OUTPUTS

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#### recommended operating conditions (see Note 4)

		MIN	MAX	UNIT	
VCC	Supply voltage		3	3.6	V
V <sub>IH</sub>	High-level input voltage $V_{CC} = 3 V$	to 3.6 V	2		V
V <sub>IL</sub>	Low-level input voltage $V_{CC} = 3 V$	to 3.6 V		0.8	V
VI	Input voltage		0	5.5	V
Vo	Output voltage	state	0	VCC	V
	Output voltage 3-state		0	5.5	V
loн	High-level output current $V_{CC} = 3 \text{ V}$			-24	mA
l <sub>OL</sub>	Low-level output current $V_{CC} = 3 V$			24	mA
Δt/Δν	$\Delta t/\Delta v$ Input transition rise or fall rate			10	ns/V
Δt/ΔV <sub>CC</sub>	Power-up ramp rate		150		μs/V
TA	Operating free-air temperature		-40	85	°C

NOTE 4: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST C	ONDITIONS	VCC	MIN	TYP	MAX	UNIT	
	I <sub>OH</sub> = -100 μA		3 V to 3.6 V	V <sub>CC</sub> -0.2				
Voн	I <sub>OH</sub> = -12 mA		3 V	2.4			V	
	I <sub>OH</sub> = -24 mA		3 V	2.2				
	I <sub>OL</sub> = 100 μA		3 V to 3.6 V			0.2		
VOL	I <sub>OL</sub> = 12 mA		3 V			0.4	V	
	I <sub>OL</sub> = 24 mA		3 V			0.55		
lį	$V_{I} = 0 \text{ to } 5.5 \text{ V}$		3.6 V			±5	μΑ	
l <sub>off</sub>	V <sub>I</sub> or V <sub>O</sub> = 5.5 V		0			±5	μΑ	
loz	V <sub>O</sub> = 0 to 5.5 V		3.6 V			±5	μΑ	
lozpu	$V_0 = 0.5 \text{ to } 2.5 \text{ V},$	OE = don't care	0 to 1.5 V			±5	μΑ	
lozpd	$V_O = 0.5 \text{ to } 2.5 \text{ V},$	OE = don't care	1.5 V to 0			±5	μΑ	
laa	$V_I = V_{CC}$ or GND	IO = 0	3.6 V			100		
Icc	$3.6 \text{ V} \le \text{V}_{\text{I}} \le 5.5 \text{ V}^{\ddagger}$					100	μΑ	
ΔlCC	One input at V <sub>CC</sub> – 0.6 V,	Other inputs at V <sub>CC</sub> or GND	3 V to 3.6 V			100	μΑ	
Ci	$V_I = V_{CC}$ or GND		3.3 V		4.5	Ī	pF	
Co	$V_O = V_{CC}$ or GND		3.3 V		6		pF	

<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC}$  = 3.3 V,  $T_A$  = 25°C.

# switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> =	UNIT	
	(INFOT)	(6617-61)	MIN	MAX	
<sup>t</sup> pd	A or B	B or A	1	4.2	ns
<sup>t</sup> en	ŌĒ	A or B	1.5	4.7	ns
<sup>t</sup> dis	ŌĒ	A or B	1.5	5.9	ns



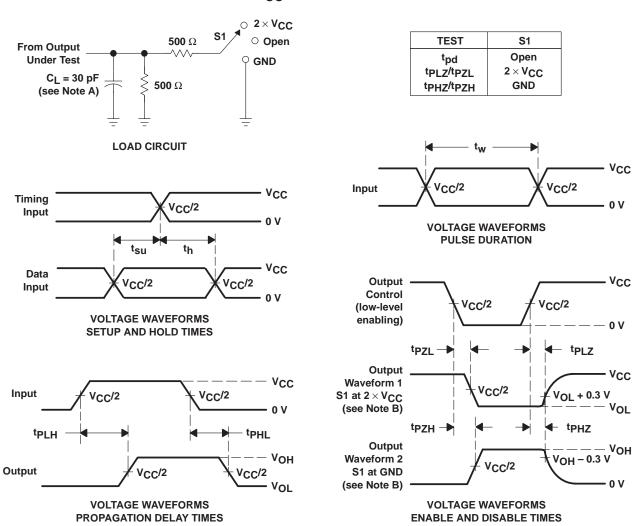
<sup>&</sup>lt;sup>‡</sup> This applies in the disabled state only.

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# operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER		TEST CONDITIONS	TYP	UNIT
C <sub>pd</sub>	Power dissination capacitance per huffer/driver	Outputs enabled	f = 10 MHz	31	pF
<sup>∪</sup> pa	Power dissipation capacitance per buffer/driver	Outputs disabled	1 = 10 101112	3.5	ρr

# PARAMETER MEASUREMENT INFORMATION $V_{CC}$ = 3.3 V $\pm$ 0.3 V



- NOTES: A. C<sub>L</sub> includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50~\Omega$ ,  $t_f \leq$  2 ns.  $t_f \leq$  2 ns.
  - D. The outputs are measured one at a time with one transition per measurement.
  - E. tpLz and tpHz are the same as tdis.
  - F. tpzL and tpzH are the same as ten.
  - G. tpLH and tpHL are the same as t<sub>Dd</sub>.

Figure 1. Load Circuit and Voltage Waveforms



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